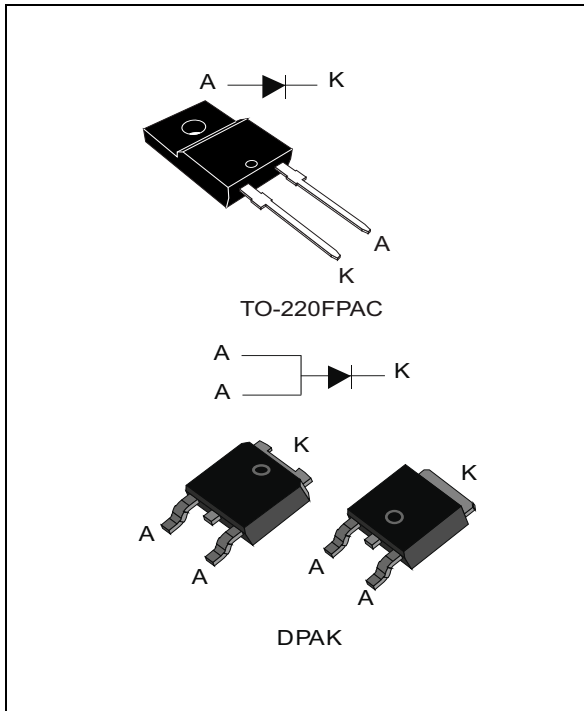


Turbo 2 ultrafast - high voltage rectifier for flat panel displays

Datasheet - production data



Description

The STTH10LCD06 uses ST Turbo 2 technology. This device is suited for power applications in flat panel displays and especially applicable to switching power supplies in LCD.

Table 1. Device summary

Symbol	Value
$I_{F(AV)}$	10 A
V_{RRM}	600 V
$T_j(max)$	175 °C
V_F (typ)	1.3 V
t_{rr} (typ)	35 ns

Features

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduce conduction and switching losses
- ECOPACK[®]2 compliant component for DPAK on demand
- Insulated package: TO-220FPAC
 - Insulated voltage: 2000 V_{RMS} sine

1 Characteristics

Table 2. Absolute ratings (limiting values at 25 °C, unless otherwise stated)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		600	V
I _{F(RMS)}	RMS forward current	DPAK	18	A
		TO-220FPAC	35	
I _{F(AV)}	Average forward current, δ = 0.5, square wave	DPAK	10	A
		TO-220FPAC		
			T _c = 105° C	
			T _c = 55° C	
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms Sinusoidal	100	A
T _{stg}	Storage temperature range		-65 to + 175	°C
T _j	Maximum operating junction temperature ⁽¹⁾		175	°C

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case	DPAK	3.5	°C/W
		TO-220FPAC	6	

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25° C	V _R = V _{RRM}			5	µA
		T _j = 150° C			13	130	
V _F ⁽²⁾	Forward voltage drop	T _j = 25° C	I _F = 10 A			2	V
		T _j = 150° C			1.3	1.6	

1. Pulse test: t_p = 5 ms, δ < 2%
 2. Pulse test: t_p = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 1.20 \times I_{F(AV)} + 0.040 I_{F(RMS)}^2$$

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse recovery time	$I_F = 1\text{ A}$, $di_F/dt = -50\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$, $T_j = 25\text{ }^\circ\text{C}$		35	50	ns
I_{RM}	Reverse recovery current	$I_F = 10\text{ A}$, $di_F/dt = -50\text{ A}/\mu\text{s}$, $V_R = 400\text{ V}$, $T_j = 125\text{ }^\circ\text{C}$		2.0	2.8	A
t_{fr}	Forward recovery time	$I_F = 10\text{ A}$, $di_F/dt = 100\text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \times V_{Fmax}$, $T_j = 25\text{ }^\circ\text{C}$			230	ns
V_{FP}	Forward recovery voltage	$I_F = 10\text{ A}$, $di_F/dt = 100\text{ A}/\mu\text{s}$, $V_{FR} = 1.1 \times V_{Fmax}$, $T_j = 25\text{ }^\circ\text{C}$		4		V

Figure 1. Conduction losses versus average current

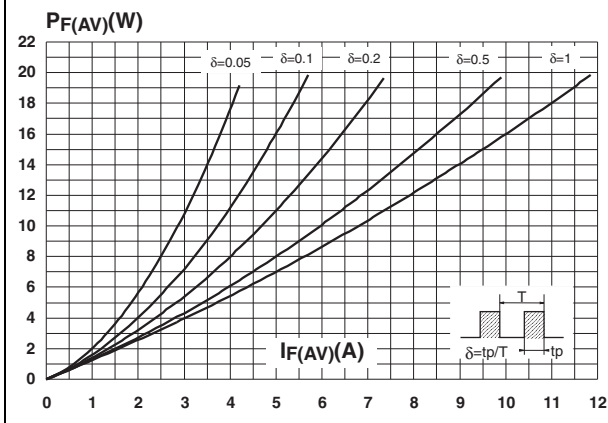


Figure 2. Forward voltage drop versus forward current

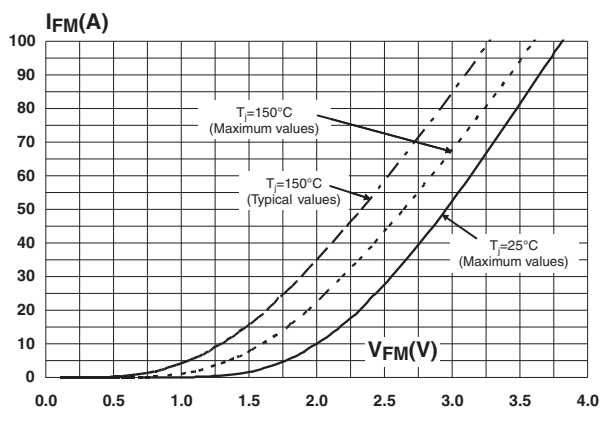


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration (DPAK)

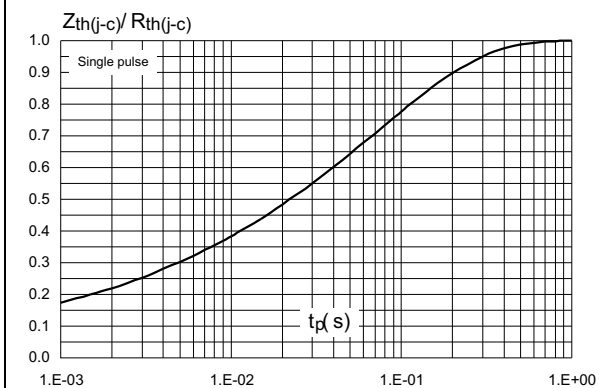


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration (TO-220FPAC)

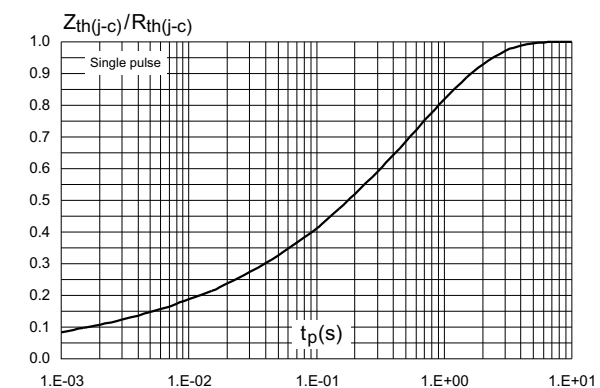


Figure 5. Peak reverse recovery current versus di_F/dt (typical values)

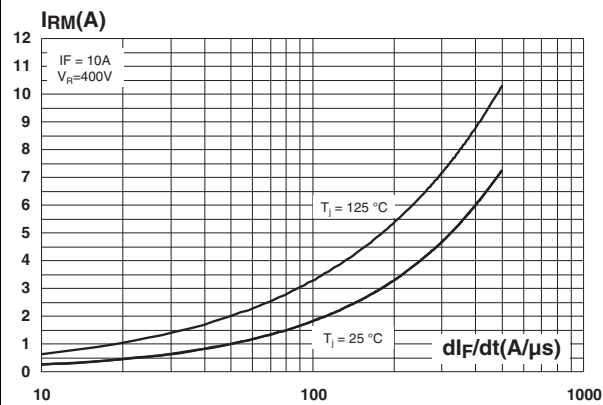


Figure 6. Reverse recovery time versus di_F/dt (typical values)

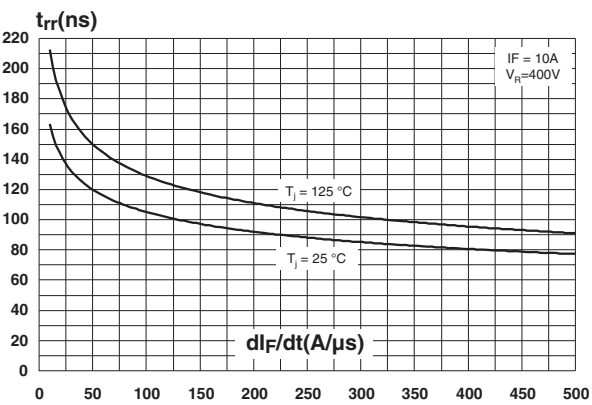


Figure 7. Reverse recovery charges versus di_F/dt (typical values)

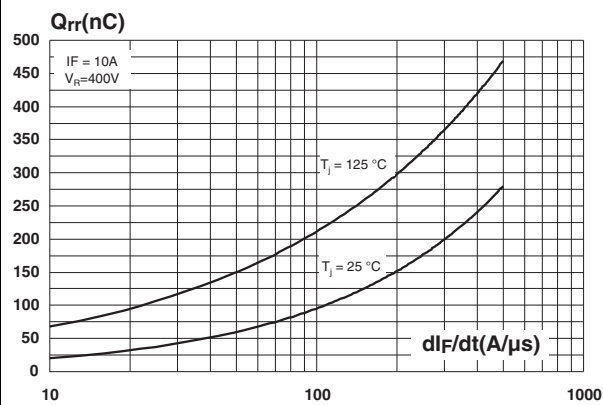


Figure 8. Relative variations of dynamic parameters versus junction temperature

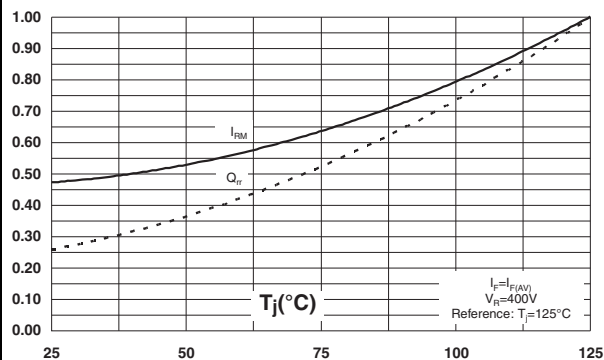


Figure 9. Transient peak forward voltage versus di_F/dt (typical values)

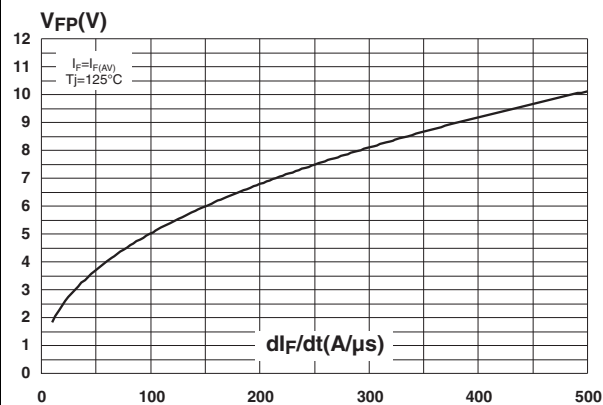


Figure 10. Forward recovery time versus di_F/dt (typical values)

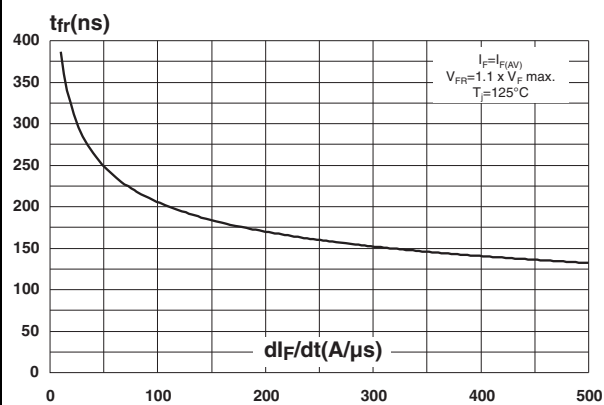
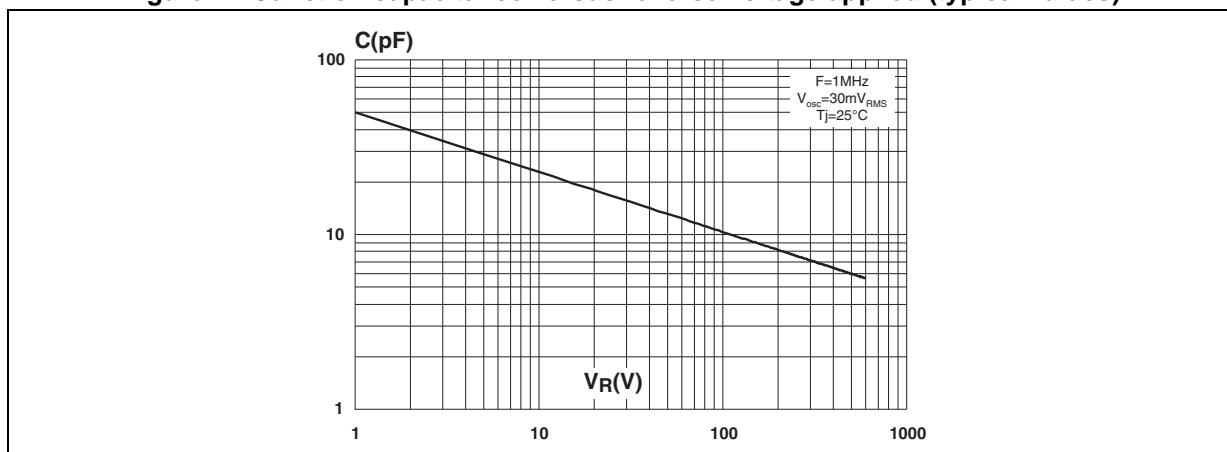


Figure 11. Junction capacitance versus reverse voltage applied (typical values)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque values: 0.55 N·m for TO-220FPAC
- Maximum torque value: 0.7 N·m for TO-220FPAC

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 TO-220FPAC package information

Figure 12. TO-220FPAC package outline

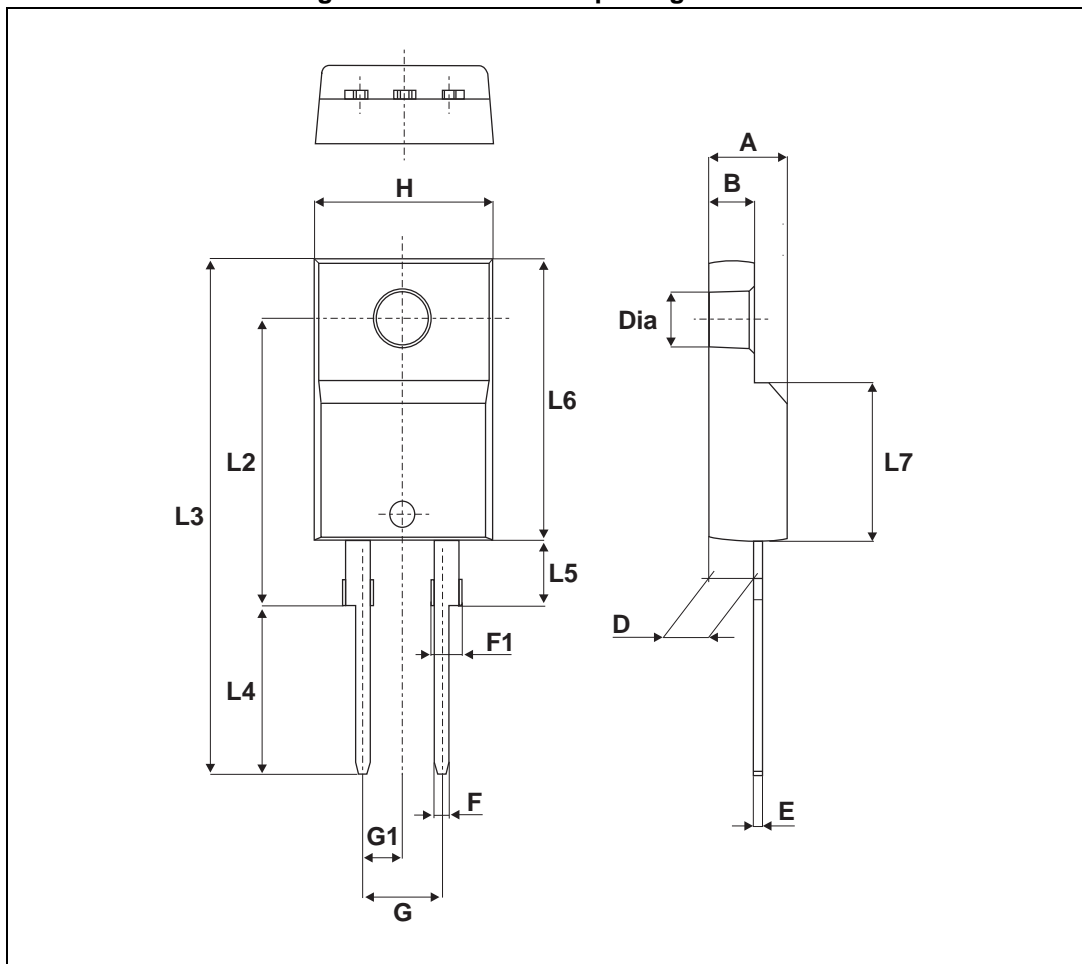
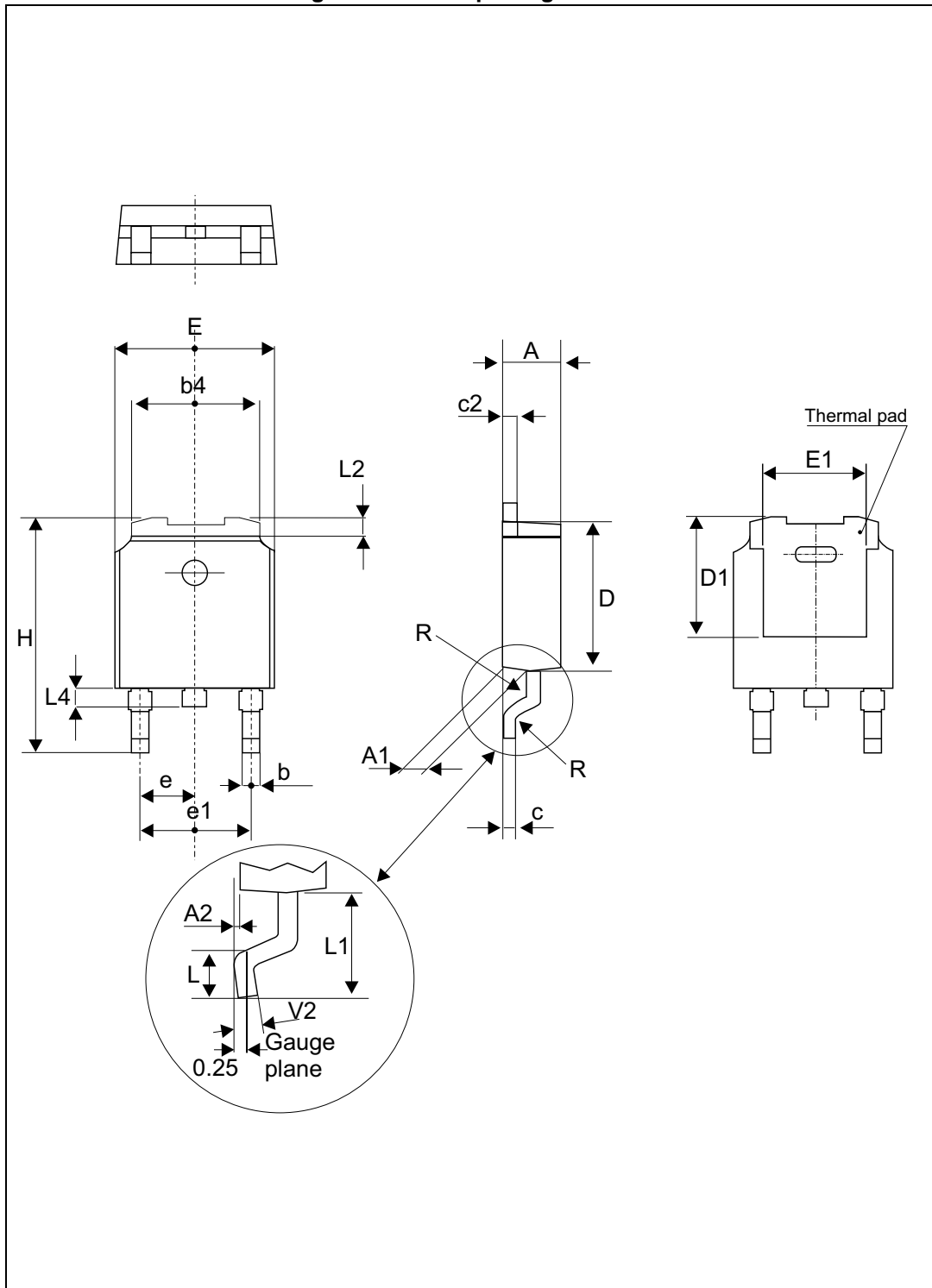


Table 6. TO-220FPAC package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	2.50		2.70	0.098		0.106
D	2.50		2.75	0.098		0.108
E	0.45		0.70	0.018		0.027
F	0.75		1.00	0.030		0.039
F1	1.15		1.70	0.045		0.067
G	4.95		5.20	0.195		0.205
G1	2.40		2.70	0.094		0.106
H	10.00		10.40	0.393		0.409
L2		16.00 Typ.			0.630 Typ.	
L3	28.60		30.60	1.126		1.205
L4	9.80		10.60	0.386		0.417
L6	15.90		16.40	0.626		0.646
L7	9.00		9.30	0.354		0.366
Dia.	3.00		3.20	0.118		0.126

2.2 DPAK package information

Figure 13. DPAK package outline

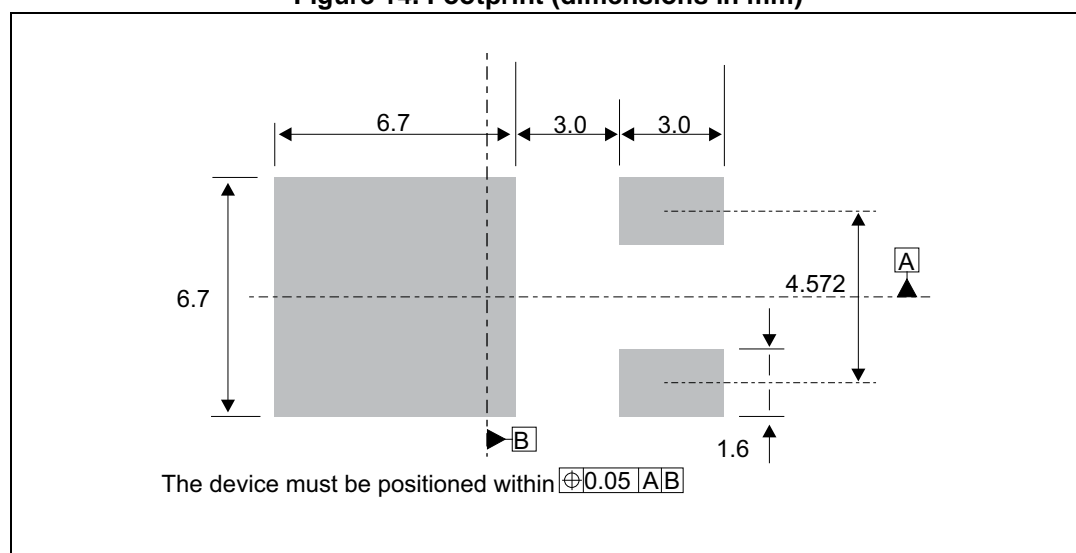


Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 7. DPAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.18		2.40	0.085		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.194		0.214
c	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	4.95			0.194		
E	6.35		6.73	0.250		0.264
E1	4.32			0.170		
e		2.28			0.090	
e1	4.40		4.70	0.173		0.185
H	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2			1.27			0.050
L4	0.60		1.02	0.023		0.040
V2	-8°		+8°	-8°		8°

Figure 14. Footprint (dimensions in mm)



3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH10LCD06FP	STTH10LCD06FP	TO-220FPAC	1.9 g	50	Tube
STTH10LCD06SB-TR	TH10LCD06S	DKPAK	1.8 g	2500	Tape and reel

4 Revision history

Table 9. Document revision history

Date	Revision	Changes
14-May-2008	1	First issue.
23-Oct-2008	2	Updated DKPAK package information and reformatted to current standard.
13-Nov-2015	3	Removed TO-220FPAC and D ² PAK package information. Updated DKPAK package information and reformatted to current standard.

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